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PATENT

## PATENT COOPERATION TREATY

Applicants : Shigeki Satou et al.

Int'l Application No. : PCT/JP2005/004607

Int'l Filing Date : March 16, 2005

Title : DIELECTRIC PASTE FOR A MULTI-LAYERED  
CERAMIC ELECTRONIC COMPONENT AND A  
METHOD FOR MANUFACTURING A MULTI-  
LAYERED UNIT FOR A MULTI-LAYERED CERAMIC  
ELECTRONIC COMPONENT

Docket No. : 890050.547USPC

Date : September 14, 2006

Mail Stop PCT  
P.O. Box 1450  
Alexandria, VA 22313-1450

INFORMATION DISCLOSURE STATEMENT TRANSMITTAL

Commissioner for Patents:

In accordance with 37 CFR 1.56 and 1.97 through 1.98, applicants wish to make known to the U.S. Patent and Trademark Office the references set forth on the attached Information Disclosure Statement. Copies of cited U.S. patents and published patent applications are not required and accordingly have not been provided. Copies of any other cited references are enclosed. As to any reference cited, applicants do not admit that it is "prior art" under 35 U.S.C. §§ 102 or 103, and specifically reserve the right to traverse or antedate any such reference, as by a showing under 37 CFR 1.131 or other method. Although the aforesaid references are made known to the Patent and Trademark Office in compliance with applicants' duty to disclose all information they are aware of which is believed relevant to the examination of the above-identified application, applicants believe that their invention is patentable.

IAP16 Rec'd PCT/PTO 14 SEP 2006  
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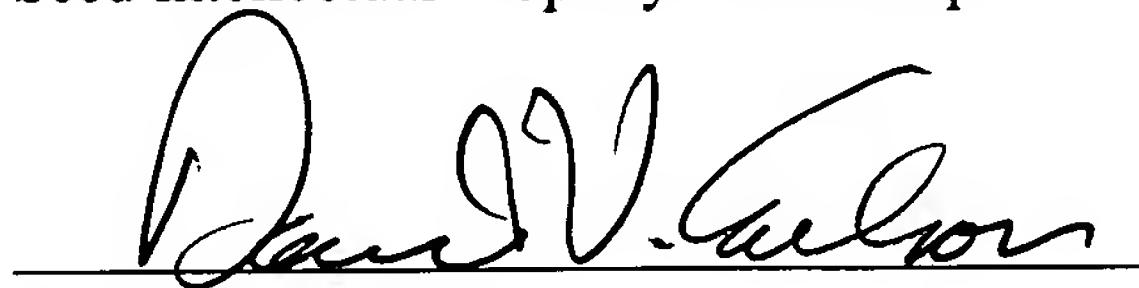
Please acknowledge receipt of this Information Disclosure Statement and kindly make the cited references of record in the above-identified application.

Applicants attorney states that a co-pending case filed today bearing the title "DIELECTRIC PASTE FOR A MULTI-LAYERED CERAMIC ELECTRONIC COMPONENT AND A METHOD FOR MANUFACTURING A MULTI-LAYERED UNIT FOR A MULTI-LAYERED CERAMIC ELECTRONIC COMPONENT", PCT application number PCT/JP2005/004606 and an International Filing Date of March 16, 2005. These two applications are in the same general technology areas and we wish to provide this information to the Examiner.

Applicants believe this Information Disclosure Statement has been timely filed, however, the Director is authorized to charge any fee due by way of this Information Disclosure Statement to our Deposit Account No. 19-1090.

Respectfully submitted,

Seed Intellectual Property Law Group PLLC



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Enclosures:

Information Disclosure Statement  
Cited References (10)

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U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE		ATTY. DOCKET NO. 890050.547USPC	APPLICATION NO. <b>10/592967</b>
INFORMATION DISCLOSURE STATEMENT (Use several sheets if necessary)		APPLICANTS Shigeki Satou et al.	
		FILING DATE March 16, 2005	GROUP ART UNIT

**U.S. PATENT DOCUMENTS**

*EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
	AA						
	AB						
	AC						
	AD						
	AE						
	AF						
	AG						
	AH						

**FOREIGN PATENT DOCUMENTS**

		DOCUMENT NUMBER	DATE	COUNTRY	TRANSLATION	
					YES	NO
	AI	05-006709	01/14/93	JP (+ Abstract in English)		
	AJ	05-325633	12/10/93	JP (+ Abstract in English)		
	AK	6-502966	03/31/94	JP (+Abstract in English)		
	AL	06-236827	08/23/94	JP (+Abstract in English)		
	AM	06-321619	11/22/94	JP (+Abstract in English)		
	AN	07-021832	01/24/95	JP (+Abstract in English)		
	AO	07-021833	01/24/95	JP (+Abstract in English)		
	AP	08-111346	04/30/96	JP (+Abstract in English)		
	AQ	11-031634	02/02/99	JP (+Abstract in English)		
	AR	11-273987	10/08/99	JP (+Abstract in English)		

**OTHER PRIOR ART** (*Including Author, Title, Date, Pertinent Pages, Etc.*)

AS		
EXAMINER	DATE CONSIDERED	

\* EXAMINER: Initial if reference considered, whether or not criteria is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant(s).